In re Appln. of MORIWAKI et al. Application No. Unassigned

CLAIM AMENDMENTS

- 1. (Currently Amended) A high-frequency An integrated circuit device comprising: a semiconductor amplification element; and
- a bias circuit for applying a bias voltage to the semiconductor amplification element; wherein a power source of the bias circuit is connected to a power source of the semiconductor amplification element via a semiconductor element such that idle current of the semiconductor amplification element ean be is changed in response to change of a supply voltage of the semiconductor amplification element.
- 2. (Currently Amended) The high-frequency integrated circuit device according to Claim 1, wherein the semiconductor element is a transistor.
- 3. (Currently Amended) The high-frequency integrated circuit device according to Claim 1, wherein the semiconductor element is a diode.
- 4. (Currently Amended) The high-frequency integrated circuit device according to Claim 1, which acts as a power amplifier circuit including a high-frequency transistor as the semiconductor amplification element, wherein the bias circuit includes a bias generating circuit for generating a base bias of the high-frequency transistor and a temperature compensation circuit for performing temperature compensation of the bias generating circuit.